Specifications for Approval

C	Customer Part N	0.:	
lı	nhere Part No.:	S1608BHMAMGT-001	
P	Part Name: 1608	B 橙绿双色 LED	
S	Spec Issue Date:	2018-09-18	
F	Revision No.: A		
■ Sample			LED Dimension
	Characteristics Curv recommendation	ve ■Internal Circuit	Diagram
Prepared by: Li Date: 2018-09-		Checked by: Tom Date: 2018-09-18	Approved by: Wangxiaojun Date: 2018-09-18
	inion d no objection the following reaso	on:	



东莞市银河光电有限公司 DongGuan Inhere Opto CO.,LTD. 地址:东莞市莞城科技园 D 幢 ADD:Guancheng Science & Technology Park, DongGuan TEL: 0769-23320868 FAX: 0769-23320878

E-mail: bill@inhereopto.com Http://www.inhereopto.com

Features

1.6mm x 0.8mm SMD LED, 0.6mm thickness

Low power consumption

Wide view angle

Package: 4000pcs/reel

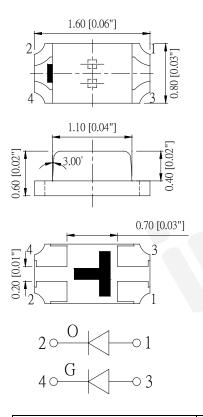
RoHS Compliant

Applications

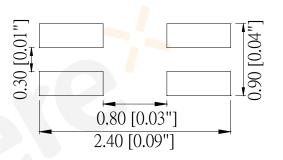
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout





Part No.	Emitted color	Dice	Lens color
	Orange	AlGaInP	
S1608BHMAMGT-001	Green	InGaN/GaN	Water transparent

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

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Absolute Maximum Ratings (Ta=25℃)

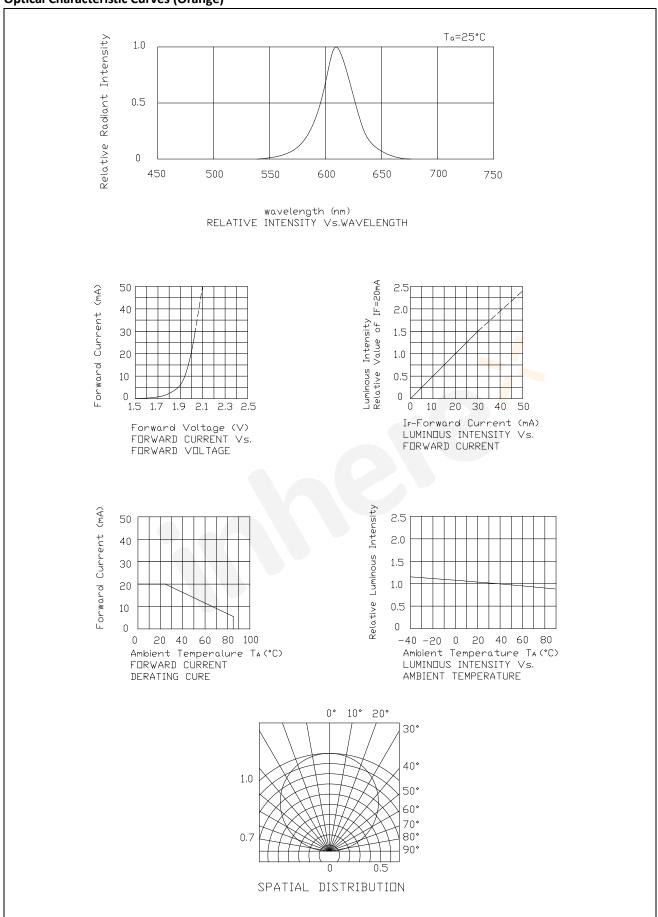
Demonstra	Symbol	Value		11
Parameter		0	G	Unit
Power dissipation	Pd	72	111	mW
Forward current	If	30		mA
Reverse voltage	Vr	5		V
Operating temperature	Тор	-40 ~+80		°C
Storage temperature	Tstg	-40 ~+85		°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	1	25	mA

Electro-Optical Characteristics (Ta=25°C)

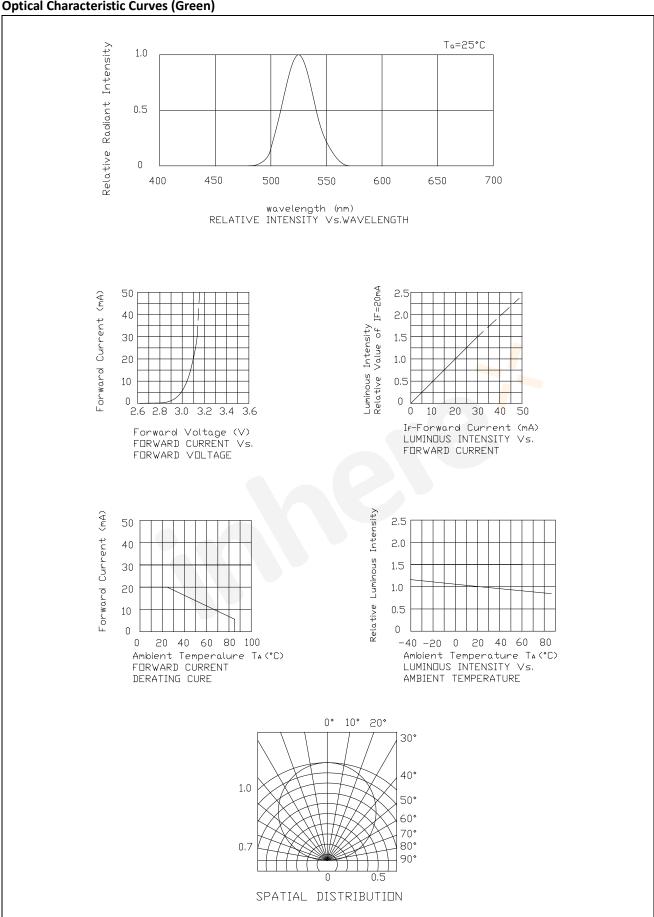
Downwater	Test	Symbol		Value			Unit
Parameter	Condition			Min	Тур	Max	Oc
Wavelength at peak emission	If=20mA	λр	0		610		nm
Waterengen at peak emission	20.1.7.	۲	G		517		
Spectral half bandwidth	If=20mA	Δλ	0		19		nm
Spectral Hall Dalluwidth	11-20111A	<u> </u>	G		35		11111
Dominant wavelength	If=20mA	ο λ d G	0	600		610	nm
Dominant wavelength			G	520		530	
Forward voltage	If=20mA	Vf	0	1.8		2.4	V
Totward voitage	II-ZUIIIA	VI	G	2.8		3.7	V
Luminous intensity	If=20mA Iv	by	0	100	175		mcd
Lummous intensity		G	320	500		med	
Viewing angle at 50% Iv	If=10mA	2 θ 1 ,	/2		120	-	Deg
Reverse current	Vr=5V	lr				10	μΑ

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Optical Characteristic Curves (Orange)



Optical Characteristic Curves (Green)

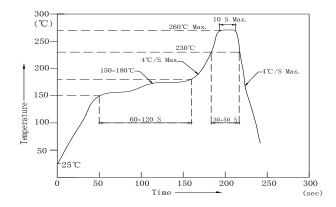


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Reflow Profile

■ Reflow Temp/Time



Notes:

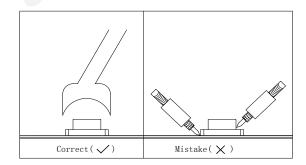
- 1. We recommend the reflow temperature 245 $^{\circ}$ C (±5 $^{\circ}$ C).the maximum soldering temperature should be limited to 260 $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

■Rework

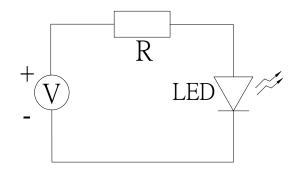
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C}^{\sim}30^{\circ}\text{C}$ and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at \leq 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60 ± 3 °C x (12~24hrs) and <5%RH, taped reel type
- 3.2 100±3°C x (45min~1hr), bulk type
- 3.3 130±3°Cx (15~30min), bulk type

Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 [°] C ,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=- 40 ± 5 $^{\circ}$ C \sim 100 ±5 $^{\circ}$ C, 15 ±1 min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30 \pm 5 $^{\circ}$ C \sim 65 \pm 5 $^{\circ}$ C, 90 \pm 5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5 °C,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5°C,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5˚C ,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5˚C ,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

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Forward Voltage Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Orange		1.8	2.4	
	f	2.8	3.1	V
Green	g	3.1	3.4	V
	h	3.4	3.7	

Luminous Intensity Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit	
	J	100	125		
	К	125	160		
Orange	L	160	200		
	М	200	250		
	N	250			
	0	320	400	mcd	
	Р	400	500		
Green	Q	500	630		
	R	630	800		
	S	800	-		

Dominant wavelength Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Orange	р	600	605	
	q	605	610	
Green	υ	520	522.5	nm
	V	522.5	525	nm
	W	525	527.5	
	Х	527.5	530	

Group Name on Label (Example DATA: ☐Lp fQU 20)

DATA: □Lp fQU 20		Vf(V)	lv (mcd)	λd (nm)	Test Condition
Orange	□ → L → p → 20	1.8~2.4	160~200	600~605	15-20m A
Green	f → Q → U → 20	2.8~3.1	500~630	520~522.5	IF=20mA

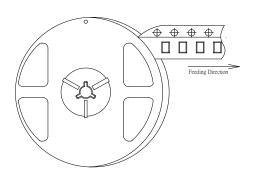
Notes:

- 1.The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.
- 2. The tolerance of dominant wavelength is ± 1 nm.
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

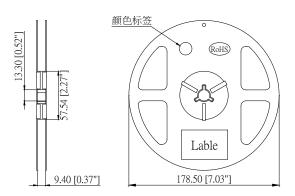
Part No.: \$1608BHMAMGT-001 Prepared by: Lily Rev.: A Checked by: Tom

1608 Series SMD Chip LED Lamps Packaging Specifications

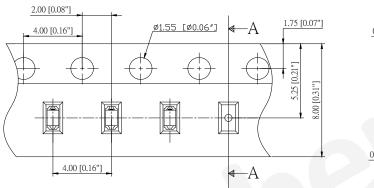
Feeding Direction

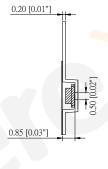


Dimensions of Reel (Unit: mm)

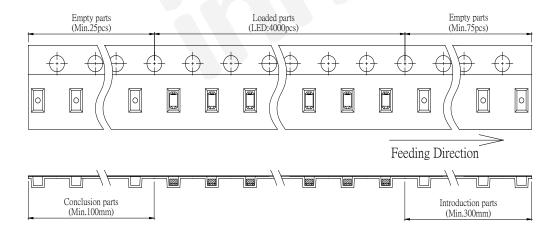


• Dimensions of Tape (Unit: mm)





Arrangement of Tape



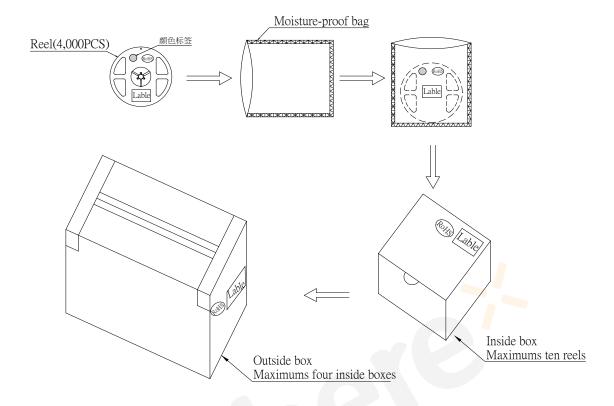
Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 4,000pcs/Reel.

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1608 Series SMD Chip LED Lamps Packaging Specifications

Packaging specifications



Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 40,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

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